

Intel® I/O Controller Hub 7 (Intel® ICH 7) Family

Specification Update

September 2013



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Revision History

Revision	Description	Date
-001	Initial Release.	April 2005
-002	Added: Errata: 2-SATA AHCI Recovery From Task File Error, 3-PCI Express* Completion Timer in L1, 4-3 Gb/s SATA Signal Voltage Level. Specification Clarifications: 1-PATA Secondary Command/Control BAR, 2-AHCI Operation Clarification.	May 2005
-003	Added: Errata: 5-SATA Index/Data Pair Decode, 6-SATA 3 Gb/s Squelch Event, 7-PCI Express* False Correctable Error. Specification Changes: 1-SATA Capability Registers Disable Change, 2-IOL1/Intel® IOH 1 Change, 3-INTVRMEN Input Threshold Change. Specification Clarifications: 3-AHCI Host Capability Register Change, 4-PCI Express* One x4 Clarification, 5-ASF Configuration Registers Clarification, 6-SM Bus Slave Read Tables, 7-Feature Detection Capability, 8-PME Pending, 9-Indeterminate State Before Power Stable.	June 2005
-004	Modified: Specification Clarification: 1-PATA Secondary Command/Control BAR. Added: Specification Clarification: 10-SATA Electrical Specification Clarification.	August 2005
-005	Specification Clarifications: 11-SPI Timings Corrections and 12-F0h Read Behavior Clarifications. Document Changes: 2-DC Current Characteristics Note Correction and 3-PCI Functional Description Correction.	September 2005
-006	Specification Clarifications: 13-PCI Downstream Device Disable Clarification, 14-Processor Initiated Passive Cooling Clarification, 15-LPC SERR Generation Behavior Clarification, and 16-t302 Clarification. Document Changes: 4-THRMTRIP# Timing Correction, 5-LSTS Note Correction, and 6-AHCI CAP.SALP Attribute Correction.	October 2005
-007	Added: Specification Change: 4-Clock Gating Support Specification Change. Document Changes: 7-Interrupt Pin Register Reserved Bits Correction, 8-PCI Express* Slot Power Register Description Additions, 9-GPIO Number Documentation Correction, and 10-USB Port Number Documentation Corrections.	November 2005
-008	Added: Specification Change: 5-Clock Gating Register Reserved Document Change: 11-LPC Cycle Change	December 2005
-009	Moved all Specification Changes, Specification Clarifications and Documentation Changes into parent datasheet (307013-002) Modified: Document Changes: 1- PCI Device Revision ID Added: Intel® ICH7DH, ICH7M, and ICH7M DH Marks Errata: 8-PCI Express* Scrambling, 9-Intel® ICH7M LPC and DMI L1, 10-Intel® ICH7M Intel® PRO/Wireless 3945ABG mode False Correctable Error during FTS with L0s, 11-Intel® ICH7M USB LS/FS Device behind a USB HS Hub, 12-Intel® ICH7M High Definition Audio Dynamic Clock Gating, 13-Intel® ICH7M PCI Dynamic Gating, 14-Intel® ICH7M Intel® PRO/Wireless 3945ABG Host Interface Auto-Detect, 15-Intel® ICH7M PCI Express*Root Port Transmission SKP Sequence during L1 Entry	January 2006
-010	Added: Specification Change: 6-GPIO25 Functional Strap Change Specification Change: 7-Intel® ICH7M SKU Change	February 2006

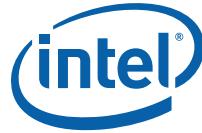


Revision	Description	Date
-011	Added: Specification Change: 8-t200 Change Specification Clarification: 1-GNT[5:0]# Pull-up Clarification	March 2006
-012	Added: Erratum: 16-MW DMA Mode-1 Tdh Erratum Specification Clarification: 2-GPIO25 Functional Strap Clarification Document Changes: 2-ESD Register Description Correction, 3-PCI Express* Signal Name Correction, 4-t290 Clarification, 5-t293 Clarification, 6-t294 Clarification, 7-Signal "Type" Clarification, 8-Power Sequencing and Reset Signal Timings Clarification, 9-Input Signal Behavior Clarifications, 10-Vcc Clarification, 11-ATA/ATAPI-7 Support Addition	April 2006
-013	Added: Specification Clarification: 3-t232 Clarification Document Changes: 12-AZ.Dock_EN#/GPIO33 Power Plane Change	May 2006
-014	Added: Errata: 17-Intel® ICH7M and Intel® ICH7M-DH UHCI Dynamic Clocking Gating, 18-Reset Command Received Through SMBus During Suspend Specification Changes: 9-RSMRST# Timing Addition Specification Clarifications: 4-DC Characteristic Clarifications, 5-SMBus Slave Write Clarification Document Changes: 13-Package Size Correction Modified Erratum #3 to correct a formatting error. Miscellaneous formatting corrections throughout the document.	July 2006
-015	Added: Errata: 19-PCI Express* Root Port Power State Value Specification Clarifications: 6-PM1_EN Register Description Correction, 7-D29:F7 PCI Command Register Description Correction.	August 2006
-016	Added: Errata: 20-PCI Express* Upstream Link Base Address Register Bit 0 Document Changes: 14-BIOSWE Bit Clarification	September 2006
-017	Added: Errata: 21-SATA Min Squelch Marginality at Hot Temperature	November 2006
-018	Added: Specification Changes: 10-t290, t293, and t294 Timing Change and t303 Addition Specification Clarifications: 8-t290, t293, t294 Clarification Document Changes: 15-RTC Update Cycle Inhibit (SET) bit Correction	December 2006
-019	Added: Document Changes: 16-APIC Enable (AEN) Bit Clarification, 17-Reset Control Register (CF9h) Clarification, 18-TP3 Replacing RTEST#	February 2007
-020	Added: Errata: 22-IDE Input Buffer V+and Vih Specification Violation, 23-UHCI Hang with USB Reset Document Changes: 19-PWROK Glitch-free Clarification, 20-RTC Clock Clarification	March 2007
-021	Added Specifications for 82801GU Intel® ICH7-U Removed: Specification Clarifications 1-8. Items were added to Datasheet, Revision -003. Documentation Changes 2-20. Items were added to Datasheet, Revision -003.	April 2007
-022	Added: Errata: 24-High Speed (HS) USB2.0 D+ and D- Maximum Driven Signal Level, 25-THRM Polarity on SMBus	September 2007
-023	Removed Specification Changes that have been incorporated into Datasheet, Revision -003. Reset the numbering scheme in all summary tables for easy reference. Added: Errata: 26-AHCI Reset and MSI Request Specification Changes: 2-Removing Support for USB Wake from S5 Document Changes: 2-AC '97 Misc Corrections.	November 2007
-024	Added: Errata: 27-SATA Gen1 Initialization / LPM Erratum Document Changes: 3-SATA Port Control and Status Register Clarification	May 2008



Revision	Description	Date
-025	Added: Specification Clarifications: 1-t290, t293, and t294 Correction	October 2008
-026	Added: Document Change: 1.5V VccSusHDA and VccHDA support for Intel® G41\Intel® ICH 7 configuration. Specification Clarification: GPIO25 resets during PLTRST#.	April 2009
-027	Added: Errata: 28-Intel® I/O Controller Hub 7 (Intel® ICH 7) Family PCI Express* Function Disable Document Change: 5-Correct Section 5.14.7.5 Sx-G3-Sx, Handling Power Failures regarding possible wake events following a power failure Document Change: 6-Remove t217 timing from Figure 23-21.	October 2009
-028	Added: Document Change: 7 - Correct section 10.1.22 Bits 15:2 definition Document Change: 8 - Remove t302 timing requirement from Figure 23-25	May 2010
-029	Added Items: Document Changes: 9 - Correct A20M#Signal Description Document Changes: 10 - Update Section 8.2 in the Datasheet Errata: 29 - Intel® ICH 7 SATA GEN3 Device Detection	December 2010
-030	Updated: Errata: 29 - Intel® ICH 7 SATA GEN3 Device Detection	March 2011
-031	Updated: Document change: Correct OUTSTRMPAY Register information Document change: Correct INSTRMPAY Register information	December 2011
-032	Added: <ul style="list-style-type: none">Errata: 30 - Incorrect IRQ(x) Vector Returned for 8259 Interrupts With RAEOI EnabledSpecification Change: 3 - ROAEI options removal for OCW2.	May 2012
-033	Added: <ul style="list-style-type: none">Identification information (Marking) due to new SSPEC updateSpecification Change: The Intel® ICH 7 product wire bond material is changing from Gold (Au) to Copper Palladium (Cu-Pd).	September 2013

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Preface

This document is an update to the specifications contained in the [Affected Documents/Related Documents](#) table below. This document is a compilation of device and documentation errata, specification clarifications and changes. It is intended for hardware system manufacturers and software developers of applications, operating systems, or tools.

Information types defined in [Nomenclature](#) are consolidated into the specification update and are no longer published in other documents.

This document may also contain information that was not previously published.

Affected Documents/Related Documents

Title	Document Number
Intel® I/O Controller Hub 7 (ICH7) Family Datasheet	307013-003

Nomenclature

Errata are design defects or errors. Errata may cause the Intel® ICH 7's behavior to deviate from published specifications. Hardware and software designed to be used with any given stepping must assume that all errata documented for that stepping are present in all devices.

Specification Changes are modifications to the current published specifications. These changes will be incorporated in any new release of the specification.

Specification Clarifications describe a specification in greater detail or further highlight a specification's impact to a complex design situation. These clarifications will be incorporated in any new release of the specification.

Documentation Changes include typos, errors, or omissions from the current published specifications. These will be incorporated in any new release of the specification.

Note: Errata remain in the specification update throughout the product's life cycle, or until a particular stepping is no longer commercially available. Under these circumstances, errata removed from the specification update are archived and available upon request. Specification changes, specification clarifications and documentation changes are removed from the specification update when the appropriate changes are made to the appropriate product specification or user documentation (datasheets, manuals, etc.).

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Summary Tables of Changes

The following tables indicate the Errata, Specification Changes, Specification Clarifications, or Documentation Changes that apply to the Intel® I/O Controller Hub 7 (Intel® ICH 7) Family. Intel may fix some of the errata in a future stepping of the component(s), and to account for the other outstanding issues through documentation or specification changes as noted. These tables use the following notations:

Codes Used in Summary Tables

Stepping

X: Errata exists in the stepping indicated. Specification Change or Clarification that applies to this stepping.

(No mark) or (Blank Box): This erratum is fixed in listed stepping or specification change does not apply to listed stepping.

Status

Doc: Document change or update that will be implemented.

Plan Fix: This erratum may be fixed in a future stepping of the product.

Fixed: This erratum has been previously fixed.

No Fix: There are no plans to fix this erratum.

Row

Change bar to left of a table row indicates this erratum is either new or modified from the previous version of the document.



Errata

Number	Stepping		Status	ERRATA
	A1	B0		
1.	X	X	No Fix	SATA COMINIT/COMWAKE Detection
2.	X	X	No Fix	SATA AHCI Recovery From Task File Error
3.	X	X	No Fix	PCI Express* Completion Timer in L1
4.	X	X	No Fix	3 Gb/s SATA Signal Voltage Level
5.	X	X	No Fix	SATA Index/Data Pair Decode
6.	X	X	No Fix	SATA 3 Gb/s Squelch Event
7.	X	X	No Fix	PCI Express* False Correctable Error
8.	X	X	No Fix	PCI Express* Scrambling
9.	X	X	No Fix	Intel® ICH7M/ICH7-U LPC and DMI L1
10.	X	X	No Fix	Intel® ICH7M/ICH7-U Intel® PRO/Wireless 3945ABG mode False Correctable Error during FTS with LOs
11.	X	X	No Fix	Intel® ICH7M/ICH7-U USB LS/FS Device behind a USB HS Hub
12.	X	X	No Fix	Intel® ICH7M/ICH7-U High Definition Audio Dynamic Clock Gating
13.	X	X	No Fix	Intel® ICH7M/ICH7-U PCI Dynamic Gating
14.	X	X	No Fix	Intel® ICH7M/ICH7-U Intel® PRO/Wireless 3945ABG Host Interface Auto-Detect
15.	X	X	No Fix	Intel® ICH7M PCI Express* Root Port Transmission of SKP Sequence During L1 Entry
16.	X	X	No Fix	MW DMA Mode-1 Tdh Erratum
17.		X	No Fix	Intel® ICH7M/ICH7-U and Intel® ICH7M-DH UHCI Dynamic Clocking Gating
18.	X	X	No Fix	Reset Command Received Through SMBus During Suspend
19.	X	X	No Fix	PCI Express* Root Port Power State Value
20.	X	X	No Fix	PCI Express* Upstream Link Base Address Register Bit 0
21.	X		No Fix	SATA Min Squelch Marginality at Hot Temperature
22.	X	X	No Fix	IDE Input Buffer V+ and Vih Specification Violation
23.	X	X	No Fix	UHCI Hang with USB Reset
24.	X	X	No Fix	High Speed (HS) USB2.0 D+ and D- Maximum Driven Signal Level
25.	X	X	No Fix	THRM Polarity on SMBus
26.	X	X	No Fix	AHCI Reset and MSI Request
27.	X	X	No Fix	SATA Gen1 Initialization/LPM Erratum
28.	X	X	No Fix	Intel® I/O Controller Hub 7 (Intel® ICH 7) Family PCI Express* Function Disable
29.	X	X	No Fix	Intel® ICH 7 SATA 6.0 Gbps Device Detection
30.	X	X	No Fix	Incorrect IRQ(x) Vector Returned for 8259 Interrupts With RAE0I Enabled



Specification Changes

Number	Stepping		SPECIFICATION CHANGES
	A1	B0	
1.	X	X	D29:F7 PCI Command Register Description Correction
2.	X	X	Removing Support for USB Wake from S5
3.	X	X	ROAEI options removal for OCW2
4.	X	X	The Intel® ICH 7 product wire bond material is changing from Gold (Au) to Copper Palladium (Cu-Pd) due to PCN 112037

Specification Clarifications

Number	SPECIFICATION CLARIFICATIONS
1	t290, t293, and t294 Clarification
2	GPIO25 Resets During PLTRST#

Documentation Changes

Number	DOCUMENTATION CHANGES
1	PCI Device Revision ID
2	AC '97 Misc Corrections
3	SATA Port Control and Status Register Clarification
4	1.5V VccSusHDA and VccHDA Support for Intel® G41\Intel® ICH 7 Configuration
5	Correct section 5.14.7.5 Sx-G3-Sx, Handling Power Failures regarding possible wake events following a power failure
6	Remove t217 timing from Figure 23-21
7	Correct section 10.1.22 Bits 15:2 definition
8	Remove t302 timing requirement from Figure 23-25
9	Correct A20M# Signal Description
10	Update Section 8.2 in the Datasheet
11	Correct OUTSTRMPAY Register information
12	Correct INSTRMPAY Register information

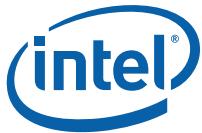


Identification Information

Markings

Intel® ICH 7 Stepping	S-Spec	Top Marking	Notes
A1	N/A	82801GB QI99 ES	Engineering Sample - ICH7 (Sn-Pb)
A1	N/A	82801GB QJ01 ES	Engineering Sample - ICH7 (Lead-free)
A1	N/A	82801GR QJ04 ES	Engineering Sample - ICH7R (RAID) (Sn-Pb)
A1	N/A	82801GR QJ05 ES	Engineering Sample - ICH7R (RAID) (Lead-free)
A1	SL8FX	82801GB SL8FX	Production - ICH7 (Lead-free)
A1	SL8FY	82801GR SL8FY	Production - ICH7R (Lead-free)
A1	SL8KL	82801GR SL8KL	Production - ICH7R (Sn-Pb)
A1	SLJZ8	82801GB SLJZ8	Production - ICH7 (Lead-free)
A1	SLJZ9	82801GR SLJZ9	Production - ICH7R (Lead-free)
A1	N/A	82801GDH QJ03ES	Engineering Sample - ICH7DH (Lead-free)
A1	N/A	82801GHM QJ09ES	Engineering Sample - ICH7M DH (Lead-free)
B0	N/A	82801GBM QK65ES	Engineering Sample - ICH7M (Lead-free)
B0	N/A	82801GHM QK17ES	Engineering Sample - ICH7M DH (Lead-free)
A1	SL8UK	82801GDH SL8UK	Production - ICH7DH (Lead-free)
B0	SL8YR	82801GHM SL8YR	Production - ICH7M DH (Lead-free)
B0	SL8YB	82801GBM SL8YB	Production - ICH7M (Lead-free)
B0	SLA23	PC82801GU	Production - ICH7-U (Lead-free)

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Errata

1. SATA COMINIT/COMWAKE Detection

Problem: During Out-Of-Band (OOB) sequencing, the Intel® ICH 7 may detect COMINIT/COMWAKE when only 2 or 3 bursts of ALIGNs are received from the SATA device instead of the required 4 bursts as per the SATA 1.0a Specification.

Implication: None Known - The Intel® ICH 7 appropriately handles subsequent ALIGNs.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

2. SATA AHCI Recovery From Task File Error

Problem: During an AHCI fatal error condition, if the device signals a Task File Error (TFES), the Intel® ICH 7 may not be able to recover correctly after software performs the AHCI spec-defined fatal error recovery mechanism.

Implication: SATA port will appear busy resulting in the device being inaccessible.

Note: IAA/IMST 4.0 and later implements a reset mechanism that does not allow this issue to be exposed. Furthermore this condition has only been replicated in a synthetic test environment.

Workaround: AHCI driver should toggle the ST bit to '1' and back to '0' upon detecting TFES bit set after ST bit is cleared.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

3. PCI Express* Completion Timer in L1

Problem: The Intel® ICH 7 PCI Express* Completion Timer always halts when the PCI Express* link enters the L1 state. According to the PCI Express specification, Rev 1.0a, the timer should continue running during Active State Power Management (ASPM)-initiated L1 states.

Implication: No known implications with devices that meet the PCI Express* 1.0a specification.

The system may hang if a PCI Express* device enters the ASPM L1 state before sending all completions for an outstanding non-posted request. Note that since the PCI Express* specification requires that endpoints send all pending completions before entering ASPM L1, a system hang of this nature requires a device that is not fully compliant with the PCI Express* specification. This issue has only been replicated in a synthetic environment.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.



4. 3 Gb/s SATA Signal Voltage Level

Problem: The Intel® ICH 7 3 Gb/s SATA transmit buffers have been designed to maximize performance and robustness over a variety of routing scenarios. As a result, the Intel® ICH 7 SATA transmit signaling voltage levels may exceed the maximum motherboard TX connector and device RX connector voltage specifications (section 6.2.1 of Serial ATA II Electrical Specification, Rev 1.0).

Implication: None known.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

5. SATA Index/Data Pair Decode

Problem: The Intel® ICH 7 SATA controller does not properly decode SATA index/data pair transactions when I/O trapping is enabled.

Implication: SATA index/data pair accesses are not required for Intel® ICH 7 configuration or functionality. If I/O trapping is enabled, SATA index/data pair register access may return unexpected data.

Workaround: BIOS workaround available. Contact your Intel field Representative for details.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

6. SATA 3 Gb/s Squelch Event

Problem: When subjected to a specific high-frequency test pattern for an extended time period with a very low receive amplitude at the motherboard connector, the Intel® ICH 7 may inaccurately detect a squelch event when the SATA link is operating at 3 Gb/s.

Implication: A squelch event may cause the 3 Gb/s SATA device to become unavailable and/or the system may hang. Note: this issue has only been replicated in an artificial test environment and has not been reported with known SATA devices. No application failures have been observed in a real world environment.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

7. PCI Express* False Correctable Error

Problem: During L0s and/or L1 entry or exit on the PCI Express* root ports, the Intel® ICH 7 may acknowledge a correctable error, which violates the PCI Express* spec, 1.0a. This is reported thru the Correctable Error Detected bit (D28:F0/F1/F2/F3/F4/F5:Offset 4Ah:bit-0) and the Receiver Error Status bit (D28:F0/F1/F2/F3/F4/F5:Offset 150h: bit-0).

Implication: No system functionality issues observed. However, correctable error logging may not accurately report the number of errors.

Note: No known end-user SW uses this logging capability.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.



8. PCI Express* Scrambling

Problem: While entering the Recovery state, the Intel® ICH 7 stops scrambling two symbols before the first TS (training sequence).

Implication: When these non-scrambled symbols are received by the endpoint, the de-scrambler of the endpoint will observe two symbols of random data. The first symbol of TS1 will reset the endpoint's de-scrambler so that the endpoint should recognize the TS1 and TS2 ordered-sets being transmitted and move into the Recovery state as planned.

There is no system level impact if the endpoint is PCI Express* Specification 1.0a compliant in ignoring the random data.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

9. Intel® ICH7M/ICH7-U LPC and DMI L1

Problem: Under certain circumstances ICH7M/ICH7-U may initiate DMI L1 entry outside of C3/C4 while intermittent burst transfers are occurring by a LPC bus master.

Implication: Possible long latency when transferring data by a LPC bus master device due to L1 exit latency.

Workaround: BIOS workaround available. Contact your Intel field representative for details.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

10. Intel® ICH7M/ICH7-U Intel® PRO/Wireless 3945ABG mode False Correctable Error during FTS with LOs

Problem: During LOs exit, the Intel® ICH 7 may erroneously report correctable receiver errors while the PCI Express* link is operating in Intel® PRO/Wireless 3945ABG mode. This is reported thru the Correctable Error Detected bit (D28:F0/F1/F2/F3/F4/F5:Offset 4Ah: bit 0) and the Receiver Error Status bit (D28:F0/F1/F2/F3/F4/F5:Offset 150h: bit 0).

Implication: No system functionality issues observed. However, correctable error logging may not accurately report the number of errors. Note: No known end-user SW uses this logging capability.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

11. Intel® ICH7M/ICH7-U USB LS/FS Device behind a USB HS Hub

Problem: Intel® ICH7M/ICH7-U incorrectly processes a split transaction when a USB Low Speed/Full Speed device is connected to Intel® ICH7M/ICH7-U through a USB High Speed Hub.

Implication: Some USB Low Speed/Full Speed devices may not function properly when connected to the Intel® ICH7M/ICH7-U root port through a USB High Speed hub.

Workaround: BIOS workaround available. Contact your Intel field representative for details.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

12. Intel® ICH7M/ICH7-U High Definition Audio Dynamic Clock Gating

Problem: Intel® ICH7M/ICH7-U may access incorrect memory location when a High Definition Audio device is installed and High Definition Audio dynamic clock gating is enabled.

Implication: Some High Definition Audio devices may not function properly with Intel® ICH7M/ICH7-U and may result in a NMI.

Workaround: BIOS workaround available. Contact your Intel field representative for details.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.



13. Intel® ICH7M/ICH7-U PCI Dynamic Gating

Problem: Intel® ICH7M/ICH7-U PCI Dynamic gating feature introduced a circuit isolation problem.

Implication: Use of PCI Dynamic Gating can severely impact product functionality.

Workaround: BIOS must ensure PCI Dynamic Gating is disabled. BIOS must ensure RCBA + 341Ch[16] = 0 during boot and resume sequence. Contact your Intel field representative for details.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

14. Intel® ICH7M/ICH7-U Intel® PRO/Wireless 3945ABG Host Interface Auto-Detect

Problem: During the Intel® ICH7M/ICH7-U auto-detect sequence for Intel® PRO/Wireless 3945ABG host interface mini-card device, there is a potential failure due to a timing, voltage, and temperature related boundary condition. Failure occurs only with Intel® PRO/Wireless 3945ABG mini-card devices.

Implication: Intermittent enumeration failures may occur with Intel® PRO/Wireless 3945ABG mini-card devices on Intel® ICH7M/ICH7-U-based platforms.

Workaround: BIOS workaround available. Contact your Intel field representative for details.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

15. Intel® ICH7M PCI Express* Root Port Transmission of SKP Sequence During L1 Entry

Problem: During L1 entry, Intel® ICH7M currently follows the PCI Express* Spec 1.0a section 5.3.2.1 and transmits a continuous stream of PM Request ACK DLLPs but will not send SKP ordered sets, as permitted by PCI Express* specification errata C7, even if the interval between SKP ordered set has exceeded the 1180 to 1538 symbol times.

Implication: With certain receiver designs that are incapable of tolerating this sequence, in such systems a hang or NMI may occur.

Workaround: None

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

16. MW DMA Mode-1 Tdh Erratum

Problem: Data hold time of MW DMA Mode-1 writes may not meet ATA specification.

Implication: None known.

Workaround: Program the controller to PIO Mode-4 instead.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.



17. Intel® ICH7M/ICH7-U and Intel® ICH7M-DH UHCI Dynamic Clock Gating

Problem: With Intel® ICH7M/ICH7-U and Intel® ICH7M-DH UHCI Dynamic Clock Gating enabled, under certain conditions, toggling the UHCI Controller Run/Stop control bit may result in the controller continuously accessing the Transaction Description Link List via DMA cycles.

- The condition may occur when clearing the UHCI Run/Stop bit between initiation and completion of an upstream UHCI memory request.
- The condition may occur with either Low-speed/Full-speed devices populated or unpopulated.
- Affects platforms with Intel® ICH7M/ICH7-U and Intel® ICH7M-DH, when UHCI Dynamic Clock Gating is enabled

Implication: The system may not enter a C-state due to continuous DMA traffic.

- A system hang may occur when entering S3/4/5 sleep state.
- The system hang case has been observed with USB Wake support enabled.

Workaround: BIOS workaround available. Contact your Intel field representative for details.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

18. Reset Command Received Through SMBus During Suspend

Problem: If the Intel® ICH 7 is sent a 'Hard Reset Without Cycling' command on SMBus while the system is in S3, the reset command will not be executed until the next wake event. The ASF Spec, rev 1.03, requires the Intel® ICH 7 to execute the Hard Reset Without Cycling immediately.

Implication: SMBus write commands that are sent after the Hard Reset Without Cycling command and before the wake event will be NAKed by the Intel® ICH 7. This also applies to any SMBus wake commands sent after a Hard Reset Without Cycling command, such that the SMBus wake command will not cause the system to wake.

Note: Intel® Active Management Technology is not impacted as Intel® AMT does not use the Hard Reset Without Cycling command while the system is in S3.

Note: Any SMBus read that is accepted by the Intel® ICH 7 will complete normally

Workaround: Do not send a Hard Reset Without Cycling command while the system is in S3.

Note: Exposure to this issue can be reduced by issuing a wake command prior to issuing the Hard Reset Without Cycling command.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

19. PCI Express* Root Port Power State Value

Problem: The Intel® ICH 7 PCI Express* root ports support the D3 and D0 states, but also accept writes of values corresponding to the D2 and D1 states in the Power State bit field of the Power Management Control and Status registers (D28:F0/F1/F2/F3/F4/F5:A4h). The Intel® ICH 7 PCI Express* root port PCI Power Management Capabilities Registers (D28:F0/F1/F2/F3/F4/F5:A2h) do not claim support of D2 and D1 power states.

Implication: No functional implications known. Writes of values corresponding to the D2 and D1 states (i.e., 10b or 01b) do not cause behavioral changes within the Intel® ICH 7, but the value is displayed in the Power State bit field.

Workaround: Software should not write unsupported power state values (i.e., 10b or 01b) to the Power State bit field of the Power Management Control and Status register.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.



20. PCI Express* Upstream Link Base Address Register Bit 0

Problem: The Intel® ICH 7 PCI Express* root ports' Upstream Link Base Address (ULBA) Register (D28:F0/F1/F2/F3/F4/F5:198h) bit 0 mirrors the value of bit 0 in the Intel® ICH 7 RCBA register (D31:F0:F0h). During normal system operation, bit 0 of the RCBA register is set to 1. This results in bit 0 of the ULBA also being set to 1. The PCI Express* specification, rev 1.0a, requires that bit 0 of the ULBA be 0.

Implication: No functional implications known.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

21. SATA Min Squelch Marginality at Hot Temperature

Problem: The Intel® ICH 7 SATA min squelch voltage may violate the SATA specification at case temperature of 85°C or above.

Implication: Squelch violation may cause a SATA drive detection failure resulting in either error message or blue screen, depending on the drive being re-detected and the type of detection scenario that is occurring: boot, system reset, active power management, resume from S3-S5, or when an error on the SATA wire is experienced.

Note: The Intel® ICH 7 case temperature is not typically above 85°C during these drive detection scenarios.

Workaround: None.

Note: Exposure to the issue can be eliminated through effective system thermal design.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

22. IDE Input Buffer V+ and Vih Specification Violation

Problem: Under maximum voltage condition of the Vcc3_3 power rail (3.465 V), the Intel® ICH 7 may violate the PATA IDE V+ max (low-to-high input threshold) and Vih2 min (input high voltage) specifications. The limit in both cases is specified as 2.0 V.

Implication: The Intel® ICH 7 may not switch on a low-to-high transition until V+ max is at 2.1 V, and may not register a logic high until Vih2 min is at 2.1 V.

There is no known impact to system functionality. This issue has only been seen in a synthetic test environment, as an IDE device typically drives the input to 3.3 V.

Workaround: None.

Status: No fix. For steppings affected, see the Summary Tables of Changes.

23. UHCI Hang with USB Reset

Problem: When SW initiates a Host Controller Reset or a USB Global Reset while concurrent traffic occurs on at least three UHCI controllers, the UHCI controller(s) may hang.

The issue has only been replicated in a synthetic reset test environment.

Implication: System may hang.

Workaround: BIOS workaround available. Contact your Intel field representative for more details.

Status: No fix. For steppings affected, see the Summary Tables of Changes.



24. High Speed (HS) USB2.0 D+ and D- Maximum Driven Signal Level

Problem: During Start-of-Packet (SOP)/End-of-Packet (EOP), the Intel® ICH 7 may drive D+ and D- lines to a level greater than USB 2.0 spec +/-200mV max.

Implication: May cause High Speed (HS) USB 2.0 devices to be unrecognized by OS or may not be readable/writable if the following two conditions are met:

- The receiver is pseudo differential design
- The receiver is not able to ignore SE1 (single-ended) state

Note: Intel has only observed this issue with a motherboard down HS USB 2.0 device using pseudo differential design. This issue will not affect HS USB 2.0 devices with complementary differential design or Low Speed (LS) and Full Speed (FS) devices.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

25. THRM Polarity on SMBus

Problem: When THRM#_POL (PMBASE+42h:bit0) is set to high, the THRM# pin state as reported to the SMBus TCO unit is logically inverted.

Implication: If the THRM#_POL bit is set to high, an external SMBus master reading the BTI Temperature Event status will not receive the correct state of the THRM# pin. The value will be logically inverted. If THRM#_POL set to low, value is correct.

Workaround: None.

Status: No Fix. For steppings affected, see the Summary Tables of Changes.

26. AHCI Reset and MSI Request

Problem: If the Intel® ICH 7 AHCI SATA controller receives a HBA reset while MSI interrupts are enabled, a boundary condition exists where the Intel® ICH 7 SATA controller may respond to a non-posted request that is intended for another Intel® ICH 7 function.

Implication: Issue has only been observed in a synthetic test environment. Unexpected system behavior may occur. System implication may vary depending on the non-posted request that is fulfilled.

Note: Intel® Matrix Storage Manager AHCI driver does not use the HBA reset command. Linux may enable MSIs and use the HBA reset command. No other third-party software known to utilize MSI interrupts.

Workaround: Prior to performing an HBA reset, software should disable AHCI interrupts by writing a '0' to Interrupt Enable bit (ABAR+04h, bit 1) and then perform a read to the AHCI GHC register (ABAR+04h).

Status: No Fix.



27. SATA Gen1 Initialization/LPM Erratum

Problem: During SATA Initialization routines or while resuming from a Link Power Managed (LPM) state, the Intel® ICH 7 SATA link to Gen1 (1.5 Gb/s) devices may fail to be established.

Implication: One or more of the following symptoms may occur:

- During Boot or Resume from S4/S5: SATA Gen1 devices may not be detected, resulting in "Operating System Not Found" error.
- During Resume from S3: System may hang when attempting to initialize SATA Gen1 devices.
- During S0: If LPM is enabled and ALL SATA Gen1 devices within the system support LPM, slow SATA Gen1 performance may occur.

Workaround: BIOS workaround available. Contact your Intel field representative for more details.

Status: No Fix. For steppings affected, see the Summary Table of Changes.

28. Intel® I/O Controller Hub 7 (Intel® ICH 7) Family PCI Express* Function Disable

Problem: Intel® ICH 7 Family PCI Express* [1:6] Disable bit in Function Disable Register may not put the PCI Express* port into a link down state if a PCI Express* device is attached.

Implication: Intel® ICH7-M:

PCI Express* port [1:6] with a PCI Express* device attached may remain in L0 state and DMI may not be able to go into L1 state.

Intel® ICH7, ICH7R, ICH7DH, ICH7-M DH, and ICH7-U:

PCI Express* port [1:6] with a PCI Express* device attached may remain in L0 state.

Workaround: A BIOS code change has been identified.

Status: No Fix. For steppings affected, see the Summary Table of Changes.

29. Intel® ICH 7 SATA 6.0 Gbps Device Detection

Problem: Intel® ICH 7 may not be able to complete SATA Out Of Band (OOB) Signaling with SATA 6.0 Gbps Devices and down shift to SATA 3.0 Gbps speed.

Implication: Intel® ICH 7 may not detect SATA 6.0 Gbps Devices upon power up or resume from S3, S4 or S5 State.

Workaround: None.

Status: No Plan to Fix. For steppings affected, see the Summary Table of Changes.

30. Incorrect IRQ(x) Vector Returned for 8259 Interrupts With RAEOI Enabled

Problem: If multiple interrupts are active prior to an interrupt acknowledge cycle with Rotating Automatic End of Interrupt (RAEOI) mode of operation enabled for 8259 interrupts (0-7), an incorrect IRQ(x) vector may be returned to the CPU.

Implication: Implications of an incorrect IRQ(x) vector being returned to the CPU are SW implementation dependent.

Note: This issue has only been observed in a synthetic test environment.

Workaround: None.

Status: No Plan to Fix. For steppings affected, see the Summary Table of Changes.

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Specification Changes

1. D29:F7 PCI Command Register Description Correction

In Section 13.1.3, the description of bit 6 in the PCI Command Register (D29:F7) is corrected as indicated below.

6	Parity Error Response—R/W. When set to 1, the EHCI Host Controller will check for correct parity and halt operation when bad parity is detected during the data phase as recommended by the EHCI specification. If it detects bad parity on the address or command phases when this bit is set to 1, the host controller does not take the cycle, halts the host controller (if currently not halted) and sets the host system error bit in the USBSTS register. Note that this applies to both requests and completions from the system interface. This bit must be set in order for the parity errors to generate SERR#.
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2. Removing Support for USB Wake from S5

Support for USB wake from S5 is removed from Datasheet as indicated below.

- a. Update Intel® ICH 7 Features page of the Datasheet as follows:

USB 2.0

- Includes four UHCI Host Controllers, supporting eight external ports
- Includes one EHCI Host Controllers that support all eight ports
- Includes one USB 2.0 High-speed Debug Ports
- Supports wake-up from sleeping states S1–S4
- Supports legacy Keyboard/Mouse software

- b. Update Table 5-31 as follows:

Table 5-31. Causes of Wake Events

Cause	States Can Wake From	How Enabled
Classic USB	S1–S4	Set USB1_EN, USB 2_EN, USB3_EN, and USB4_EN bits in GPEO_EN register



3. ROAEI options removal for OCW2

Remove bit setting "000" and "100" for Operational Control Word 2 Register bits [7:5] in section 10.4.8.

10.4.8 OCW2-Operational Control Word 2 Register (LPC I/F-D31:F0)

Offset Address:	Master Controller - 020h	Attribute:	WO
	Slave Controller - 0A0h	Size:	8 bits
Default Value:	Bit[4:0]=undefined, Bit[7:5]=001		

Following a part reset or ICW initialization, the controller enters the fully nested mode of operation. Non-specific EOI without rotation is the default. Both rotation mode and specific EOI mode are disabled following initialization.

Bit	Description
7:5	Rotate and EOI Codes (R, SL, EOI) —WO. These three bits control the Rotate and End of Interrupt modes and combinations of the two. 000 = Rotate in Auto EOI Mode (Clear) Reserved 001 = Non-specific EOI command 010 = No Operation 011 = *Specific EOI Command 100 = Rotate in Auto EOI Mode (Set) Reserved 101 = Rotate on Non-Specific EOI Command 110 = *Set Priority Command 111 = *Rotate on Specific EOI Command *L0 – L2 Are Used

4. The Intel® ICH 7 product wire bond material is changing from Gold (Au) to Copper Palladium (Cu-Pd) due to PCN 112037

Specifics of the change are:

- With recent advancements made in copper bonding, most of the assembly suppliers are switching to Cu-Pd as mainstream bonding process. Intel is following the High Volume Manufacturing (HVM) trend.
- Cu-Pd products are one-to-one pin compatible with Au products and there is no form, fit, function change.
- Refer to the Markings table in the ["Identification Information"](#) section of this document for new product codes, s-spec and MM#s.
 - The products with the new marking have identical quality and reliability as the current products.

Customer Impact of Change and Recommended Action:

- Intel is moving with the rest of the industry per JEDEC standards.
- There are no changes to form, fit or function.
- The Cu-Pd and Au parts are totally compatible with each other.
- Customers do not need to do anything different in the receipt and use of the Cu-Pd products in their manufacturing process.
- Customers could receive gold wire or copper palladium wire products until inventory is depleted.

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Specification Clarifications

1. t290, t293, and t294 Clarification

Note 14 for t290, t293, and t294 in Table 23-23 of the Datasheet is changed as indicated below:

14. t290, t293, and t294 apply during S0 to S3/S4/S5 and S0 to G3 transitions. In addition, the timings are not applied to V5REF. V5REF timings are bounded by power sequencing.

2. GPIO25 Resets During PLTRST#

The following changes apply to sections 10.10.1: GPIO_USE_SEL, 10.10.4: GPO_BLINK and 10.10.5: GPI_INV, respectively, in the Intel® ICH 7 Family Datasheet.

GPIO_USE_SEL - GPIO Use Select Register

Offset Address:	GPIOBASE+00h	Attribute:	R/W
Default Value:	1F3FF7FFh (Desktop Only) 1F2AF7FFh (Mobile/Ultra Mobile Only)	Size:	32-bits
Lockable:	No	Power Well:	Core for 0: 7, 16: 23, Resume for 8: 15, 24: 31

Note 4. After a full reset (RSMRST#) all multiplexed signals in the resume and core wells are configured as their default function. After just a PLTRST#, the GPIO in the core well and GPIO25 are configured as their default function.

GPO_BLINK - GPO Blink Enable Register

Offset Address:	GPIOBASE+18h	Attribute:	R/W
Default Value:	00040000h	Size:	32-bits
Lockable:	No	Power Well:	Core for 0: 7, 16: 23, Resume for 8: 15, 24: 31

GP_BLINK[31:0] — R/W. The setting of this bit has no effect if the corresponding GPIO signal is programmed as an input.

0 = The corresponding GPIO will function normally.

1 = If the corresponding GPIO is programmed as an output, the output signal will blink at a rate of approximately once per second. The high and low times have approximately 0.5 seconds each. The GP_LVL bit is not altered when this bit is set.

The value of the corresponding GP_LVL bit remains unchanged during the blink process, and does not effect the blink in any way. The GP_LVL bit is not altered when programmed to blink. It will remain at its previous value.

These bits correspond to GPIO in the Resume well. These bits revert to the default value based on RSMRST# or a write to the CF9h register (but not just on PLTRST#, except GPIO25). GPIO25 resets during PLTRST#.



GPI_INV - GPIO Signal Invert Register

Offset Address:	GPIOBASE+2Ch	Attribute:	R/W
Default Value:	00000000h	Size:	32-bits
Lockable:	No	Power Well:	Core for 0:7, 16:23, Resume for 8:15, 24:31

GP_INV[n] — R/W. Input Inversion: This bit only has effect if the corresponding GPIO is used as an input and used by the GPE logic, where the polarity matters. When set to 1, then the GPI is inverted as it is sent to the GPE logic that is using it. This bit has no effect on the value that is reported in the GP_LVL register.

These bits are used to allow both active-low and active-high inputs to cause SMI# or SCI. Note that in the S0 or S1 state, the input signal must be active for at least two PCI clocks to ensure detection by the Intel® ICH 7. In the S3, S4 or S5 states the input signal must be active for at least 2 RTC clocks to ensure detection. The setting of these bits has no effect if the corresponding GPIO is programmed as an output. These bits correspond to GPI that are in the resume well, and will be reset to their default values by RSMRST# or by a write to the CF9h register. GPIO25 resets during PLTSRT#.

0 = The corresponding GPI_STS bit is set when the Intel® ICH 7 detects the state of the input pin to be high.

1 = The corresponding GPI_STS bit is set when the Intel® ICH 7 detects the state of the input pin to be low.

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Document Changes

1. PCI Device Revision ID

PCI Revision ID Register values (PCI Offset 08h) for all Intel® ICH 7 functions are shown below. This information is not found in the datasheet. This is the standard reference document.

Device Function	Description	Intel® ICH 7 Dev ID ¹	Intel® ICH 7 A1 Rev ID	Intel® ICH 7 B0 Rev ID	Comments
D31, F0	LPC	27B8h	01h	N/A	Intel® ICH7, ICH7R
		27B9h	01h	02h	Intel® ICH7M, ICH7U
		27BDh	01h	02h	Intel® ICH7M DH
D31, F1	IDE	27DFh	01h	02h	
D31, F2	SATA	27C0h	01h	N/A	Desktop Non-AHCI and Non-RAID Mode ¹
		27C1h	01h	N/A	Desktop AHCI Mode ¹
		27C3h	01h	N/A	Desktop RAID Mode ¹
		27C4h	01h	02h	Mobile Non-AHCI and Non-RAID Mode ¹
		27C5h	01h	02h	Mobile AHCI Mode ¹
		27C6h	01h	02h	Intel® ICH7M DH RAID Mode ¹
D31, F3	SMBus	27DAh	01h	02h	
D30, F0	DMI to PCI Bridge	244Eh	E1h	N/A	Desktop
		2448h	E1h	E2h	Mobile, Ultra Mobile
D30, F2	AC '97 Audio	27DEh	01h	02h	
D30, F3	AC '97 Modem	27DDh	01h	02h	
D29, F0	USB UHC #1	27C8h	01h	02h	
D29, F1	USB UHC #2	27C9h	01h	02h	
D29, F2	USB UHC #3	27CAh	01h	02h	
D29, F3	USB UHC #4	27CBh	01h	02h	
D29, F7	USB EHCI	27CCh	01h	02h	
D28:F0	PCI Express* Port 1	27D0	01h	02h	
D28:F1	PCI Express Port 2	27D2	01h	02h	
D28:F2	PCI Express Port 3	27D4	01h	02h	
D28:F3	PCI Express Port 4	27D6	01h	02h	
D28:F4	PCI Express Port 5	27E0	01h	02h	Intel® ICH7R, ICH7DH, ICH7M DH



Device Function	Description	Intel® ICH 7 Dev ID ¹	Intel® ICH 7 A1 Rev ID	Intel® ICH 7 B0 Rev ID	Comments
D28:F5	PCI Express* Port 6	27E2	01h	02h	Intel® ICH7R, ICH7DH, ICH7M DH
D27:F0	Intel® High Definition Audio	27D8	01h	02h	
D8: F0	LAN	See Note 2	01h	02h	

Notes:

1. Intel® ICH 7 contains a single SATA device. The SATA Device ID is dependent upon which mode is selected by BIOS and what RAID capabilities exist in the SKU.
2. Loaded from EEPROM. If EEPROM contains either 0000h or FFFFh in the device ID location, then 27DCh is used. Refer to the Intel® ICH 7 EEPROM Map and Programming Guide for LAN Device IDs.

2. AC '97 Misc Corrections

The following changes apply to the note below Table 5-59 of the Datasheet.

Note: Throughout this document, references to D30:F2 indicate that the audio function exists in PCI Device 30, Function 2. References to D30:F3 indicate that the modem function exists in PCI Device 30, Function 3.

3. SATA Port Control and Status Register Clarification

The following change applies to Section 12.1.34 of the Datasheet.

PCS - Port Control and Status Register (SATA-D31:F2)

Address Offset: 92h-93h Attribute: R/W, R/WC, RO
Default Value: 0000h Size: 16 bits

By default, the SATA ports are set to the disabled state (bits [3:0] = '0'). When enabled by software, the ports can transition between the on, partial, and slumber states and can detect devices. When disabled, the port is in the "off" state and cannot detect any devices.

If an AHCI-aware or RAID enabled operating system is being booted then system BIOS shall insure that all supported SATA ports are enabled prior to passing control to the OS. Once the AHCI aware OS is booted it becomes the enabling/disabling policy owner for the individual SATA ports. This is accomplished by manipulating a port's PxSCTL and PxCMD fields. Because an AHCI or RAID aware OS will typically not have knowledge of the PxE bits and because the PxE bits act as master on/off switches for the ports, pre-boot software must insure that these bits are set to '1' prior to booting the OS, regardless as to whether or not a device is currently on the port.

4. 1.5V VccSusHDA and VccHDA Support for Intel® G41\Intel® ICH 7 Configuration

The following changes were made to the corresponding tables of the Intel® ICH 7 Family Datasheet to add support for 1.5V VccSusHDA and VccHDA signals on an Intel® G41\Intel® ICH 7 configuration.



Table 2-22: Power and Ground Signals

Name	Description
VccSusHDA (Mobile/Ultra Mobile or Intel® G41\Intel® ICH 7 Only)	This pin provides the suspend supply for Intel® High Definition Audio (1 pin). This pin can be either 1.5v or 3.3v. This power is not expected to be shut off unless the main battery is removed or completely drained and AC power is not available in mobile Ultra Mobile configurations or AC power is removed for Desktop Intel® G41\Intel® ICH 7 configuration. Note: In Desktop mode this signal is added to the VccSus3_3 group except as noted above for Intel® G41\Intel® ICH 7 configuration.
VccHDA (Mobile/Ultra Mobile or Intel® G41\Intel® ICH 7 Only)	This pin provides the suspend supply for Intel® High Definition Audio (1 pins). This pin can be either 1.5v or 3.3v. This power may be shut off in S3, S4, S5 or G3 states. This plane must be on in S0 and S1. Note: In Desktop mode this signal is added to the Vcc3_3 group except as noted for Intel® G41\Intel® ICH 7 configuration.

Table 23-4: DC Characteristic Input Signal Association

Symbol	Associated Signals
V _{IH11} /V _{IL11}	AC '97/Intel® High Definition Audio Signals: ACZ_SDIN[2:0], Mobile Only: AZ.Dock.RST#/GPIO34 AC '97 Signals: ACZ_BIT_CLK Strap Signals: ACZ_SDOUT, ACZ_SYNC (Strap purposes only) GPIO Signals: GPIO34 (Desktop Only) NOTE: See VIL_HDA/VIH_HDA for High Definition Audio Low Voltage Mode (Mobile/Ultra Mobile Only or Intel® G41\Intel® ICH 7 configuration)
VIH_HDA / VIL_HDA (Mobile/Ultra Mobile or Intel® G41\Intel® ICH 7 Only)	Intel® High Definition Audio Signals: ACZ_SDIN[2:0], AZ.Dock.RST#/GPIO34 NOTE: Only applies when running in Low Voltage Mode (1.5 V)

Table 23-5: DC Input Characteristics

Symbol	Parameter	Min	Max	Notes
V _{IL_HDA} (Mobile/Ultra Mobile or Intel® G41\Intel® ICH 7 Only)	Input Low Voltage		0.4(Vcc_HDA)	V
V _{IH_HDA} (Mobile/Ultra Mobile or Intel® G41\Intel® ICH 7 Only)	Input High Voltage	0.6(Vcc_HDA)		V



Table 23-6: DC Characteristic Output Signal Association

Symbol	Associated Signals
V_{OH3}/V_{OL3}	<p>PCI Signals: AD[31:0], C/BE[3:0]#, DEVSEL#, FRAME#, IRDY#, PAR, PERR#, PLOCK#, SERR#, STOP#, TRDY#</p> <p>AC '97/Intel® High Definition Audio Signals: ACZ_RST#, ACZ_SDOUT, ACZ_SYNC</p> <p>Intel® High Definition Audio Signals: ACZ_BIT_CLK</p> <p>NOTE: See VOH_HDA/VOL_HDA for High Definition Audio Low Voltage Mode (Mobile/Ultra Mobile or Intel® G41\Intel® ICH 7 configuration Only)</p>
V_{OH_HDA}/V_{OL_HDA} (Mobile/ Ultra Mobile or Intel® G41\ Intel® ICH 7 Only)	<p>Intel® High Definition Audio Signals: ACZ_RST#, ACZ_SDOUT, ACZ_SYNC</p> <p>NOTE: Only applies when running in Low Voltage Mode (1.5 V)</p>

Table 23-7: DC Output Characteristics

Symbol	Parameter	Min	Max	Unit	IOL/IOH	Notes
VOL_HDA (Mobile/ Ultra Mobile or Intel® G41\ Intel® ICH 7 Only)	Output Low Voltage		0.1(VccHDA)	V	1.5 mA	
VOH_HDA (Mobile/ Ultra Mobile or Intel® G41\ Intel® ICH 7 Only)	Output High Voltage	0.9(Vcc_HDA)		V	-0.5 mA	

Table 23-8: Other DC Characteristics

Symbol	Parameter	Min	Max	Unit	Notes
VccSusHDA (Mobile/ Ultra Mobile or Intel® G41\ Intel® ICH 7 Only)	High Definition Audio Controller Low Voltage Mode the Suspend Voltage	1.425000	1.575000	V	Same as VccSus3_3 if not in low voltage mode
VccHDA (Mobile/ Ultra Mobile or Intel® G41\ Intel® ICH 7 Only)	High Definition Audio Controller Low Voltage Mode Core Voltage	1.425	1.575	V	Same as Vcc3_3 if not in low voltage mode



5. **Correct section 5.14.7.5 Sx-G3-Sx, Handling Power Failures regarding possible wake events following a power failure**

Correct section 5.14.7.5 Sx-G3-Sx, Handling Power Failures in the Datasheet.

Section 5.14.7.5 Sx-G3-Xs, Handling Power Failures

Depending on when the power failure occurs and how the system is designed, different transitions could occur due to a power failure.

The AFTER_G3 bit provides the ability to program whether or not the system should boot once power returns after a power loss event. If the policy is to not boot, the system remains in an S5 state (unless previously in S4). ~~There are only three possible events that will wake the system after a power failure.~~ The following wake events can wake the system following a power loss by either RSMRST# going low and enabling by default, the enable bits reside in the RTC well or the wake event is always enabled.

1. PWRBTN#: PWRBTN# is always enabled as a wake event. When RSMRST# is low (G3 state), the PWRBTN_STS bit is reset. When the Intel® ICH 7 exits G3 after power returns (RSMRST# goes high), the PWRBTN# signal is already high (because Vcc-standby goes high before RSMRST# goes high) and the PWRBTN_STS bit is 0.

2. RI#: RI# does not have an internal pull-up. Therefore, if this signal is enabled as a wake event, it is important to keep this signal powered during the power loss event. If this signal goes low (active), when power returns the RI_STS bit is set and the system interprets that as a wake event.

3. RTC Alarm: The RTC_EN bit is in the RTC well and is preserved after a power loss. Like PWRBTN_STS the RTC_STS bit is cleared when RSMRST# goes low.

4. PCI Express* Wake# Signal: The PCIEXPWAK_DIS bit is cleared by RSMRST# going low enabling PCI Express Ports to wake the platform after a power loss. The PCIEXPWAK_STS bit is also cleared when RSMRST# goes low.

5. PME_BO: PME_BO_EN is in the RTC Well and is preserved after a power loss. The PME_BO_STS bit is also cleared when RSMRST# goes low.

6. PME: PME_EN: is in the RTC Well and is preserved after a power loss. The PME_STS bit is also cleared when RSMRST# goes low.

7. Host SMBUS: SMBALERT# or Slave Wake message is always enabled as Wake Event

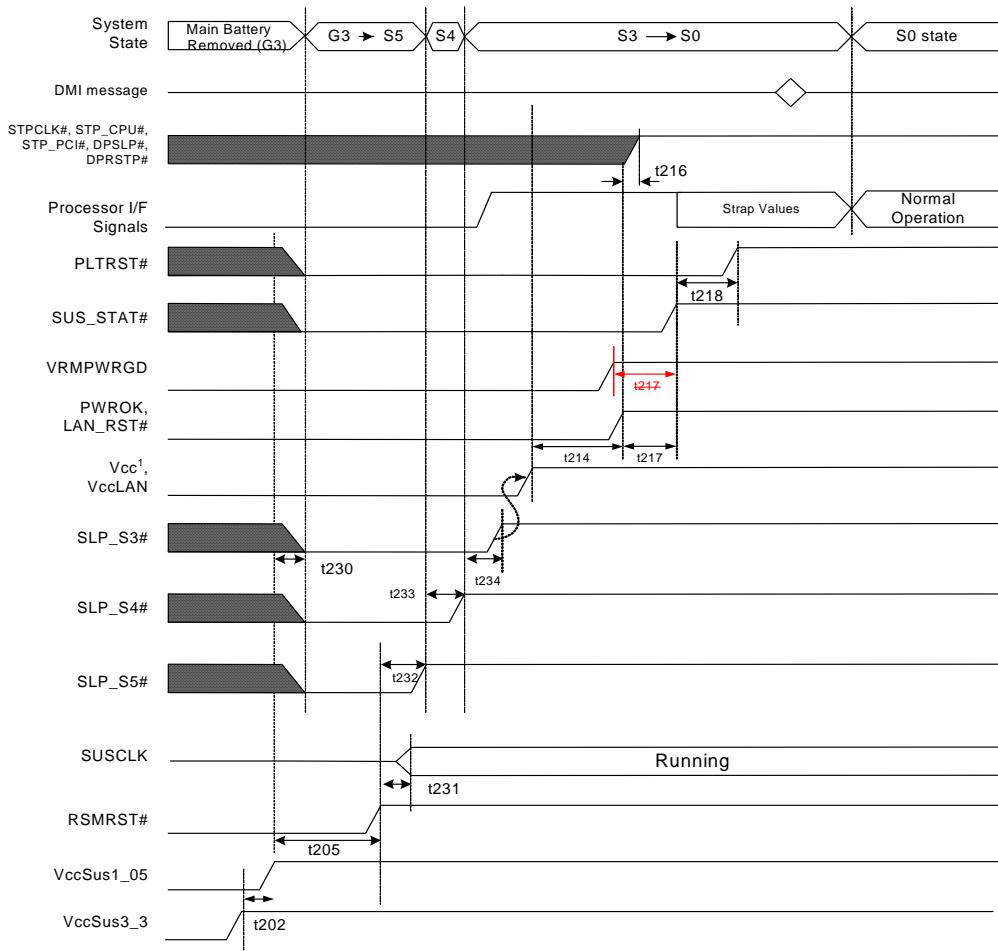
The Intel® ICH 7 monitors both PWROK and RSMRST# to detect for power failures. If PWROK goes low, the PWROK_FLR bit is set. If RSMRST# goes low, PWR_FLR is set.

~~Note: Although PME_EN is in the RTC well, this signal cannot wake the system after a power loss. PME_EN is cleared by RTCRST#, and PME_STS is cleared by RSMRST#.~~

6. Remove t217 timing from Figure 23-21

Remove t217 timing that points from VRMPWRGD going high to SUS_STAT# going high from Figure 23-21: G3 (Mechanical Off) to S0 Timings (Mobile/Ultra Mobile Only) in the Datasheet.

Figure 23-21: G3 (Mechanical Off) to S0 Timings (Mobile/Ultra Mobile Only)





7. Correct section 10.1.22 Bits 15:2 definition

Correct section 10.1.22 GEN1_DEC-LPC I/F Generic Decode Range 1 Register in the Datasheet

10.1.22 GEN1_DEC-LPC I/F Generic Decode Range 1 Register (LPC I/F-D31:F0)

Offset Address: 84h–87h Attribute: R/W
Default Value: 00000000h Size: 32 bit
 Power Well: Core

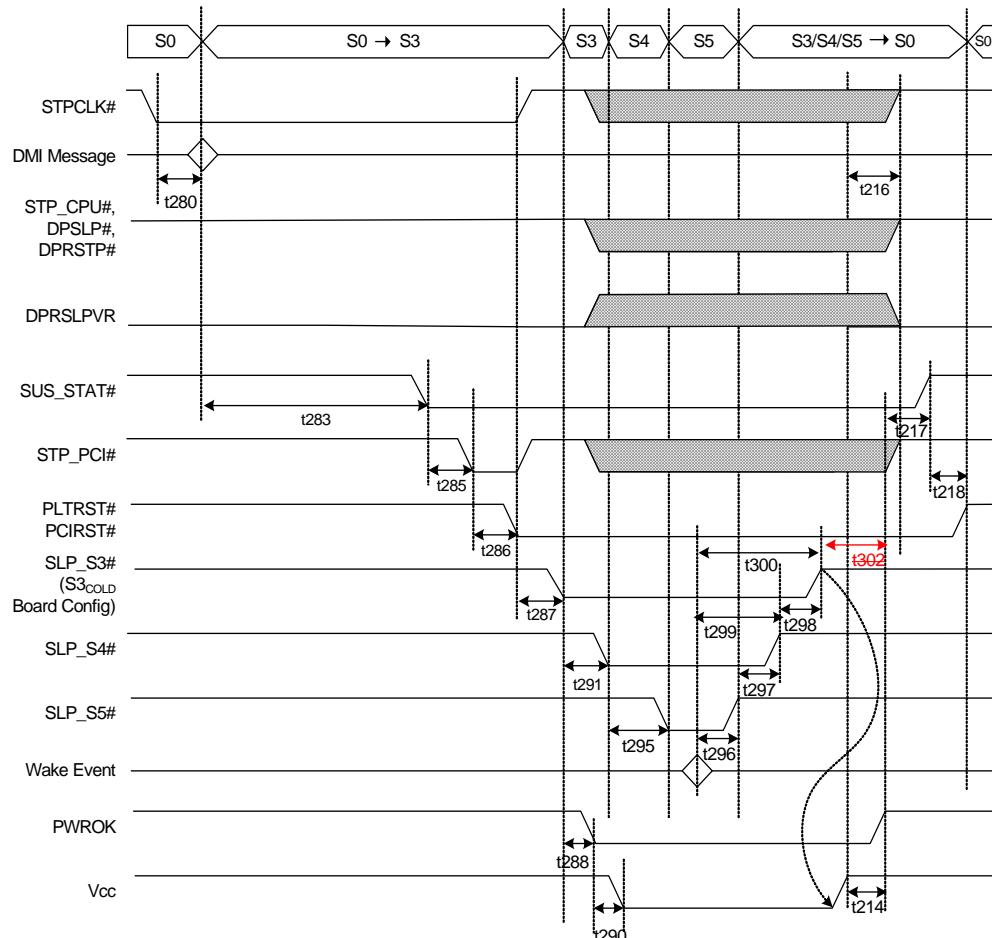
Bit	Description
31:24	Reserved
23:18	Generic I/O Decode Range Address[7:2] Mask — R/W. A 1 in any bit position indicates that any value in the corresponding address bit in a received cycle will be treated as a match. The corresponding bit in the Address field, below, is ignored. The mask is only provided for the lower 6 bits of the DWord address, allowing for decoding blocks up to 256 bytes in size.
17:16	Reserved
15:2	Generic I/O Decode Range 1 Base Address (GEN1_BASE) — R/W. This address is aligned on a 128-byte boundary, and must have address lines 31:16 as 0. NOTE: The ICH Does not provide decode down to the word or byte level.
1	Reserved
0	Generic Decode Range 1 Enable (GEN1_EN) — R/W. 0 = Disable. 1 = Enable the GEN1 I/O range to be forwarded to the LPC I/F.

8.

Remove t302 timing requirement from Figure 23-25

Remove the t302 timing requirement from Figure 23-25 S0 to S5 to S0 Timing, S3_cold (Mobile/Ultra Mobile Only) in the Datasheet.

Figure 23-25 S0 to S5 to S0 Timings, S3_cold (Mobile/Ultra Mobile Only)



9.

Correct A20M# Signal Description

Correct A20M# signal description in Table 2-12: Processor Interface Signals in the Intel® ICH 7 Datasheet.

Name	Type	Description
A20M#	O	Mask A20: A20M# will go active-inactive based on either setting the appropriate bit in the Port 92h register, or based on the A20GATE input being active.



10. Update Section 8.2 in the Datasheet

The title of section 8.2 of the Intel® ICH 7 Datasheet is changed as below.

8.2 Absolute Maximum and Minimum Ratings

The following paragraphs are added to section 8.2:

Table 8-1 specifies absolute maximum and minimum ratings. At conditions outside functional operation condition limits, but within absolute maximum and minimum ratings, neither functionality nor long-term reliability can be expected. If a device is returned to conditions within functional operation limits after having been subjected to conditions outside these limits (but within the absolute maximum and minimum ratings) the device may be functional, but with its lifetime degraded depending on exposure to conditions exceeding the functional operation condition limits.

At conditions exceeding absolute maximum and minimum ratings, neither functionality nor long-term reliability can be expected. Moreover, if a device is subjected to these conditions for any length of time, it will either not function or its reliability will be severely degraded when returned to conditions within the functional operating condition limits.

Although the Intel® ICH 7 contains protective circuitry to resist damage from Electro-Static Discharge (ESD), precautions should always be taken to avoid high static voltages or electric fields.



11. Correct OUTSTRMPAY Register information

Section 19.2.11 of the Datasheet is updated as follows:

OUTSTRMPAY—Output Stream Payload Capability (Intel® High Definition Audio Controller—D27:FO)

Memory Address: HDBAR + 18h Attribute: RO
Default Value: 0030h Size: 16 bits

Bit	Description
15:8 15:14	Reserved Output FIFO Padding Type (OPADTYPE) — RO. This field indicates how the controller pads the samples in the controller's buffer (FIFO). Controllers may not pad at all or may pad to byte or memory container sizes. 0h = Controller pads all samples to bytes 1h = Reserved 2h = Controller pads to memory container size 3h = Controller does not pad and uses samples directly
7:0 13:0	Output Stream Payload Capability (OUTSTRMPAY) — RO. This field indicates maximum number of words per frame for any single output stream. This measurement is in 16 bit word quantities per 48 kHz frame. The maximum supported is 48 Words (96B); therefore, a value of 30h is reported in this register. The value does not specify the number of words actually transmitted in the frame, but is the size of the data in the controller buffer (FIFO) after the samples are padded as specified by OPADTYPE. Thus, to compute the supported streams, each sample is padded according to OPADTYPE and then multiplied by the number of channels and samples per frame. If this computed value is larger than OUTSTRMPAY, then that stream is not supported. The value specified is not affected by striping. Software must ensure that a format that would cause more Words per frame than indicated is not programmed into the Output Stream Descriptor Register. 00h = 0 words 01h = 1 word payload ... FFh = 255h word payload The value may be larger than the OUTPAY register value in some cases.



12. Correct INSTRMPAY Register information

Section 19.2.12 of the Datasheet is updated as follows:

INSTRMPAY—Input Stream Payload Capability (Intel® High Definition Audio Controller—D27:FO)

Memory Address: HDBAR + 1Ah Attribute: RO
Default Value: 0018h Size: 16 bits

Bit	Description
15:8	Reserved
15:14	Input FIFO Padding Type (IPADTYPE) — RO. This field indicates how the controller pads the samples in the controller's buffer (FIFO). Controllers may not pad at all or may pad to byte or memory container sizes. 0h = Controller pads all samples to bytes 1h = Reserved 2h = Controller pads to memory container size 3h = Controller does not pad and uses samples directly
7:0	Input Stream Payload Capability (INSTRMPAY) — RO. This field indicates the maximum number of Words per frame for any single input stream. This measurement is in 16-bit Word quantities per 48-kHz frame. The maximum supported is 24 Words (48B); therefore, a value of 18h is reported in this register. The value does not specify the number of words actually transmitted in the frame, but is the size of the data as it will be placed into the controller's buffer (FIFO). Thus, samples will be padded according to IPADTYPE before being stored into controller buffer. To compute the supported streams, each sample is padded according to IPADTYPE and then multiplied by the number of channels and samples per frame. If this computed value is larger than INSTRMPAY, then that stream is not supported. As the inbound stream tag is not stored with the samples it is not included in the word count. The value may be larger than INPAY register value in some cases, although values less than INPAY may also be invalid due to overhead. Software must ensure that a format that would cause more Words per frame than indicated is not programmed into the Input Stream Descriptor Register. 00h = 0 words 01h = 1 word payload ... FFh = 255h word payload

§ §